## **Amendment to the Claims:**

The listing of claims will replace all prior versions, and listings of claims in the application:

## **Listing of Claims**:

1. (Previously Presented) An antenna comprising:

an element; and wherein

the element is formed from conductor patterns on a plurality of layers including at least one buried layer of a multilayer PCB, and the conductor patterns are in stacked relation and interconnected through the PCB.

- 2. (Original) An antenna according to claim 1, wherein the element is located at the edge of the PCB.
- 3. (Previously Presented) An antenna according to claim1, wherein the PCB is apertured adjacent to the element.
- 4. (Previously Presented) An antenna according to claim 2, wherein the PCB is apertured adjacent to the element.

- 5. (Previously Presented) An inverted-F antenna according to claim 1, comprising an F-shaped conductor pattern on a first layer of the PCB and an I-, L- or F-shaped conductor pattern on the or each other layer, wherein the or each I-, L- or F-shaped conductor pattern comprises an upright substantially coextensive with the upright of the F-shaped conductor pattern on the first layer.
- 6. (Original) An antenna according to claim 5, wherein the or each I-, L- or F-shaped conductor pattern extends along the edge of the PCB.
- 7. (Original) An antenna according to claim 6, wherein the PCB is apertured between the "upright" of the F-shaped conductor pattern and a ground plane area.
- 8. (Previously Presented) An antenna according to claim 7, wherein the PCB has a slot between the upright of the F-shaped conductor pattern and a ground plane area.
- 9. (Original) An antenna according to claim 1, including an antenna ground plane comprising a plurality of vias connecting ground plane regions on respective PCB layers.
- 10. (Previously Presented) An antenna according to claim 9, wherein the conductor patterns are elongated and each longitudinally extend at the edge of the PCB.

- 11. (Original) An antenna according to claim 10, wherein the PCB is apertured adjacent to the element.
- 12. (Original) An antenna according to claim 11, wherein the PCB is apertured adjacent to the element.
- 13. (Previously Presented) An inverted-F antenna according to claim 9, comprising an F-shaped conductor pattern on a first layer of the PCB and an I-, L- or F-shaped conductor pattern on the or each other layer, wherein the or each I-, L- or F-shaped conductor pattern comprises an upright substantially coextensive with the "upright" of the F-shaped conductor pattern on the first layer.
- 14. (Original) An antenna according to claim 13, wherein the or each I-, L- or F-shaped conductor pattern extends along the edge of the PCB.
- 15. (Previously Presented) An antenna according to claim 14, wherein the PCB is apertured between the upright of the F-shaped conductor pattern and a ground plane area.
- 16. (Previously Presented) An antenna according to claim 15, wherein the PCB has a slot between the upright of the F-shaped conductor pattern and a ground plane area.

- 17. (Previously Presented) A mobile phone including an antenna comprising an element formed from conductor patterns on a plurality of layers including at least one buried layer of a multilayer PCB, wherein the conductor patterns are in stacked relation and interconnected through the PCB.
- 18. (Currently Amended) An antenna A mobile phone according to claim 17, wherein the conductor patterns are elongated and each longitudinally extend at the edge of the PCB.
- 19. (Currently Amended) An antenna A mobile phone according to claim 18, wherein the PCB is apertured adjacent to the element.
- 20. (Currently Amended) An antenna A mobile phone according to claim 17, wherein the PCB is apertured adjacent to the element.
- 21. (Currently Amended) An inverted-F antenna A mobile phone according to claim 17, comprising an F-shaped conductor pattern on a first layer of the PCB and an I-, L- or F-shaped conductor pattern on the or each other layer, wherein the or each I-, L- or F-shaped conductor pattern comprises an upright substantially coextensive with the upright of the F-shaped conductor pattern on the first layer.
- 22. (Currently Amended) An antenna A mobile phone according to claim 21, wherein the or each I-, L- or F-shaped conductor pattern extends along the edge of the PCB.

- 23. (Currently Amended) An antenna A mobile phone according to claim 22, wherein the PCB is apertured between the upright of the F-shaped conductor pattern and a ground plane area.
- 24. (Currently Amended) An antenna A mobile phone according to claim 23, wherein the PCB has a slot between the upright of the F-shaped conductor pattern and a ground plane area.
- 25. (Currently Amended) An antenna A mobile phone according to claim 17, including an antenna ground plane comprising a plurality of vias connecting ground plane regions on respective PCB layers.
- 26. (Currently Amended) An antenna A mobile phone according to claim 25, wherein the conductor patterns are elongated and each longitudinally extend at the edge of the PCB.
- 27. (Currently Amended) An antenna A mobile phone according to claim 26, wherein the PCB is apertured adjacent to the element.
- 28. (Currently Amended) An antenna A mobile phone according to claim 27, wherein the PCB is apertured adjacent to the element.

- 29. (Currently Amended) An inverted F antenna A mobile phone according to claim 25, comprising an F-shaped conductor pattern on a first layer of the PCB and an I-, L- or F-shaped conductor pattern on the or each other layer, wherein the or each I-, L- or F-shaped conductor pattern comprises an upright substantially coextensive with the upright of the F-shaped conductor pattern on the first layer.
- 30. (Currently Amended) An antenna A mobile phone according to claim 29, wherein the or each I-, L- or F-shaped conductor pattern extends along the edge of the PCB.
- 31. (Currently Amended) An antenna A mobile phone according to claim 30, wherein the PCB is apertured between the upright of the F-shaped conductor pattern and a ground plane area.
- 32. (Currently Amended) An antenna A mobile phone according to claim 31, wherein the PCB has a slot between the upright of the F-shaped conductor pattern and a ground plane area.
- 33. (Previously Presented) An antenna in accordance with claim 1 wherein; interconnection of the conductor patterns is from the conductor patterns through the at least one buried layer.

- 34. (Previously Presented) An antenna in accordance with claim 33 wherein: the interconnection is by vias extending through the at least one buried layer of the PCB.
- 35. (Currently Amended) An antenna A mobile phone in accordance with claim 17 wherein;

interconnection of the conductor patterns is from the conductor patterns through the at least one buried layer.

36. (Currently Amended) An antenna A mobile phone in accordance with claim 35 wherein:

the interconnection is by vias extending through the at least one buried layer of the PCB.